

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

David R. Hembree

**Serial No.:** 10/624,332

**Filed:** July 22, 2003

**For:** CHIP ON BOARD AND HEAT SINK  
ATTACHMENT METHODS

**Confirmation No.:** 6977

**Examiner:** C. Lee

**Group Art Unit:** 2812

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**Notice of Allowance Mailed:**

February 21, 2007

**VIA ELECTRONIC FILING**  
**May 16, 2007**

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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JRD/dlm

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